

2SK3149

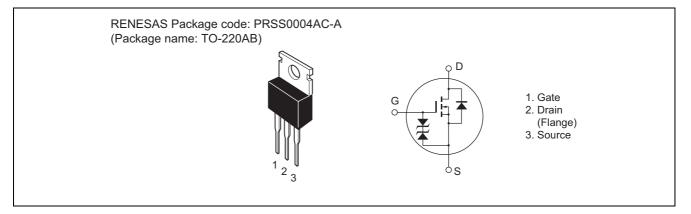
Silicon N Channel MOS FET High Speed Power Switching

> REJ03G1074-0400 (Previous: ADE-208-767C) Rev.4.00 Sep 07, 2005

Features

- Low on-resistance $R_{DS} = 45 \text{ m}\Omega \text{ typ.}$
- High speed switching
- 4 V gate drive device can be driven from 5 V source

Outline





Absolute Maximum Ratings

			$(Ta = 25^{\circ}C)$
Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	100	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	ID	20	А
Drain peak current	Note1 I _{D(pulse)}	80	А
Body-drain diode reverse drain current	I _{DR}	20	А
Avalanche current	I _{AP} Note3	20	А
Avalanche energy	E _{AR} ^{Note3}	40	mJ
Channel dissipation	Pch Note2	50	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. $PW \le 10\mu s$, duty cycle $\le 1 \%$

2. Value at Tc = 25°C

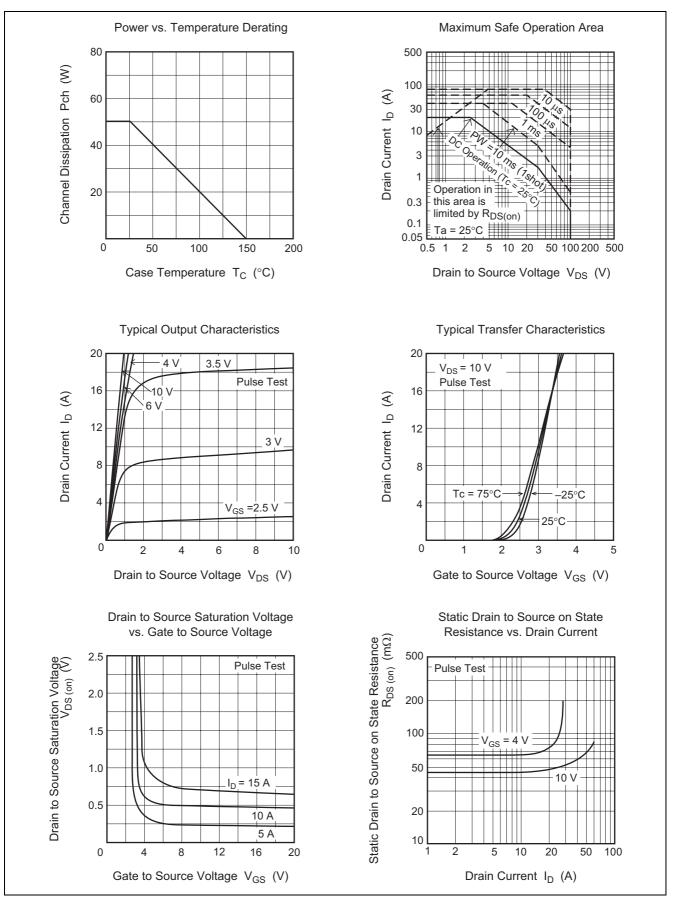
3. Value at Tch = 25°C, Rg \geq 50 Ω

Electrical Characteristics

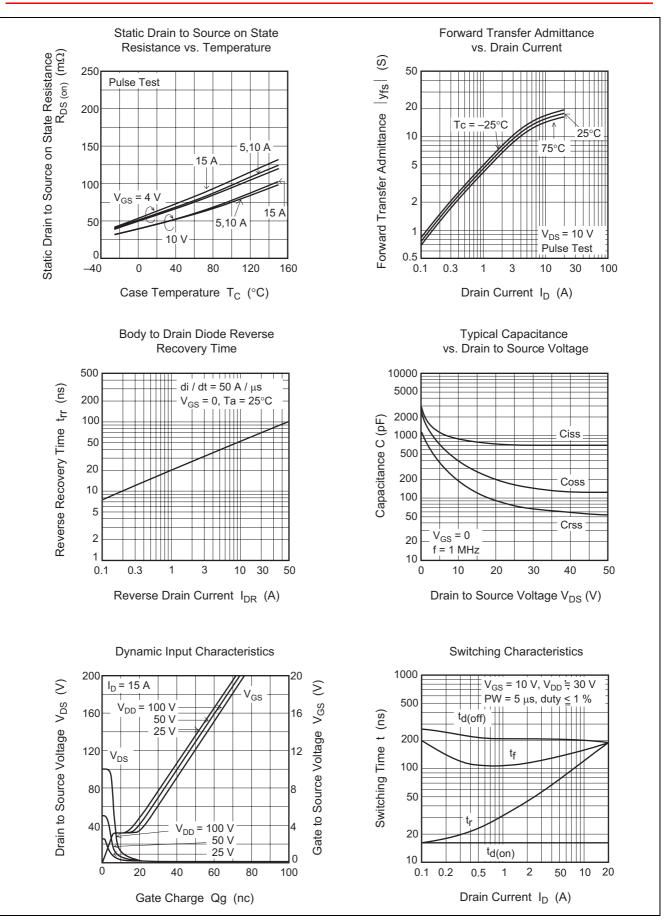
						(Ta = 25°C)
ltem	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	V _{(BR)DSS}	100	—	_	V	$I_D = 10 \text{ mA}, V_{GS} = 0$
Gate to source breakdown voltage	V _{(BR)GSS}	±20	—	_	V	$I_G = \pm 100 \ \mu A, \ V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	—	±10	μΑ	$V_{GS} = \pm 16 \text{ V}, V_{DS} = 0$
Zero gate voltage drain current	I _{DSS}	_	—	10	μΑ	$V_{DS} = 100 \text{ V}, V_{GS} = 0$
Gate to source cutoff voltage	V _{GS(off)}	1.0	—	2.5	V	$I_D = 1 \text{ mA}, V_{DS} = 10 \text{ V}$
Static drain to source on state	R _{DS(on)}	_	45	60	mΩ	$I_D = 10 \text{ A}, V_{GS} = 10 \text{ V}^{Note4}$
resistance	R _{DS(on)}	_	65	85	mΩ	$I_D = 10 \text{ A}, V_{GS} = 4 \text{ V}^{Note4}$
Forward transfer admittance	y _{fs}	8.5	14	_	S	$I_D = 10 \text{ A}, V_{DS} = 10 \text{ V}^{Note4}$
Input capacitance	Ciss	_	900	_	pF	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0,$ f = 1MHz
Output capacitance	Coss	_	400	_	pF	
Reverse transfer capacitance	Crss	_	210	_	pF	
Turn-on delay time	t _{d(on)}	_	15	_	ns	$I_{D} = 10 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$ $R_{L} = 3 \Omega$
Rise time	tr	_	120	_	ns	
Turn-off delay time	t _{d(off)}	_	200	_	ns	
Fall time	t _f	_	150	_	ns	
Body–drain diode forward voltage	V _{DF}	_	0.9	_	V	$I_F = 20 \text{ A}, V_{GS} = 0$
Body–drain diode reverse recovery	t _{rr}		90		ns	I _F = 20 A, V _{GS} = 0
time						di _F / dt = 50 A/µs

Note: 4. Pulse test

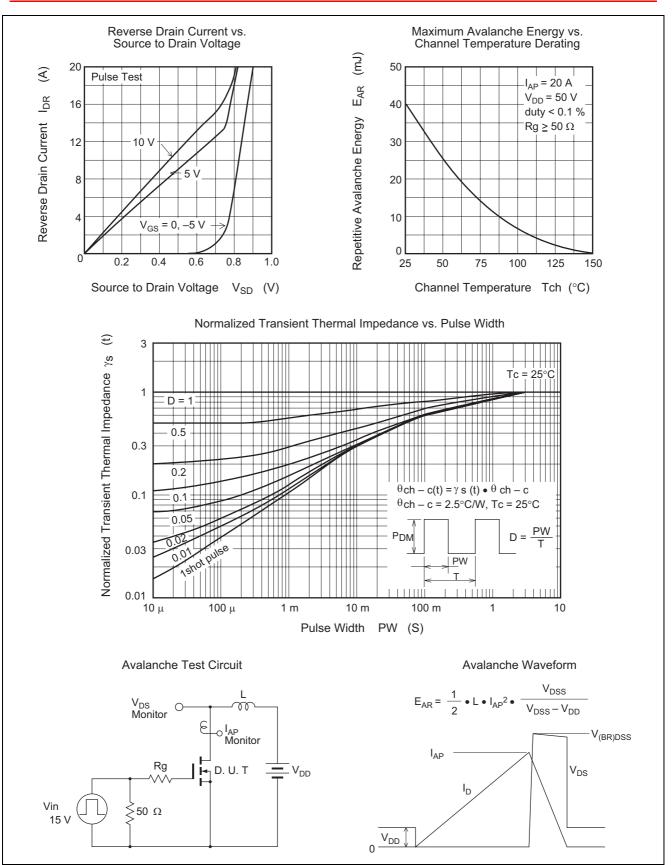
Main Characteristics



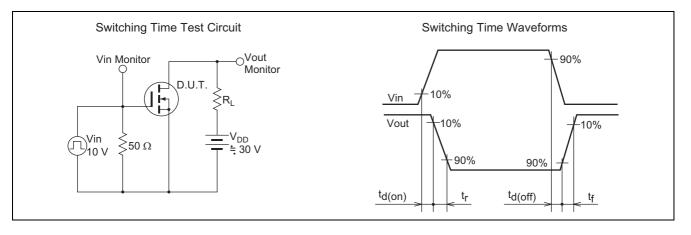






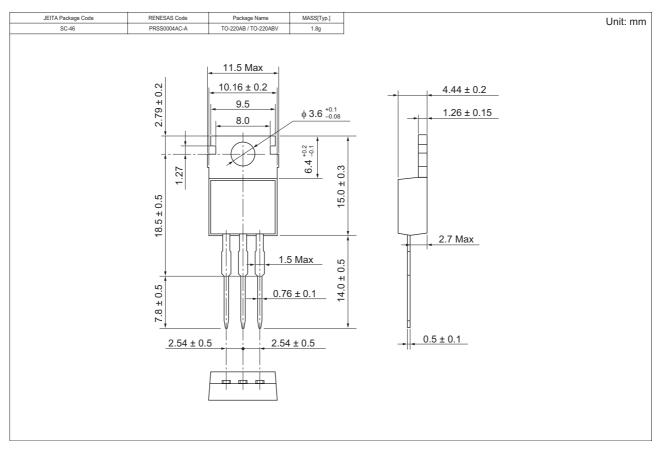








Package Dimensions



Ordering Information

Part Name	Quantity	Shipping Container
2SK3149-E	500 pcs	Box (Sack)

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